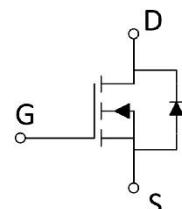
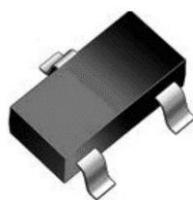


20V_{DS} N-Channel Enhancement Mode MOSFET

Features

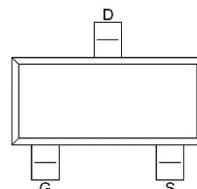
- $V_{DS}=20V, I_D=2.1A$
- $R_{DS(ON)}=28m\Omega$ (TYP.) $V_{GS}=4.5V$
- Reliable and Rugged
- Avalanche Rated
- Low On-Resistance

SOT-23



Applications

- Load Switch
- Power management in portable/desktop PCs
- DC/DC conversion



Ordering Information

| Device | Package | | Marking | Package Qty. |
|---------|---------|---------|---------|--------------|
| ME2302B | SOT-23 | Pb-Free | S2 | 3000pcs/Reel |

Absolute Maximum Ratings ($T_c=25^\circ C$,unless otherwise noted)

| Parameter | Symbol | Value | Unit |
|--|----------------|---------|------|
| Drain-Source Voltage ($V_{GS}=0V$) | V_{DS} | 20 | V |
| Gate-Source Voltage ($V_{GS}=0V$,static) | V_{GS} | ± 8 | V |
| Continuous Drain Current ($T_c=25^\circ C$) | I_D | 2.1 | A |
| Continuous Drain Current ($T_c=100^\circ C$) | | 0.6 | A |
| Maximum Power Dissipation ($T_c=25^\circ C$) | P_D | 0.4 | W |
| Operating,Storage Temperature Range | T_J, T_{STG} | -55~150 | °C |

Thermal Characteristics

| Parameter | Symbol | Min. | Typ. | Max. | Unit |
|--|-----------------|------|------|------|------|
| Thermal Resistance,Junction-to-Case | $R_{\theta JC}$ | - | 60 | - | °C/W |
| Thermal Resistance,Junction-to-Ambient | $R_{\theta JA}$ | - | 125 | - | °C/W |

Electrical Characteristics

| Parameter | Symbol | Test Conditions | Min. | Typ. | Max. | Unit |
|----------------------------------|--------------|-------------------------------|------|------|-----------|-----------|
| Drain-Source Breakdown Voltage | BV_{DSS} | $V_{GS}=0V, I_D=250\mu A$ | 20 | - | - | V |
| Zero Gate Voltage Drain Current | I_{DSs} | $V_{DS}=24V, V_{GS}=0V$ | - | - | 1 | μA |
| Gate -Source Leakage Current | I_{GSS} | $V_{GS}=\pm 12V, V_{DS}=0V$ | - | - | ± 100 | nA |
| Gate Threshold Voltage | $V_{GS(th)}$ | $V_{DS}=V_{GS}, I_D=250\mu A$ | 0.65 | 0.95 | 1.2 | V |
| Drain-Source On-stage Resistance | $R_{DS(ON)}$ | $V_{GS}=4.5V, I_D=2.8A$ | - | 35 | 60 | $m\Omega$ |
| | | $V_{GS}=2.5V, I_D=2.5A$ | - | 45 | 115 | |

Dynamic Characteristics

| Parameter | Symbol | Test Conditions | Min. | Typ. | Max. | Unit |
|------------------------------|--------------|-----------------|------|------|------|------|
| Input capacitance | C_{iss} | $V_{DS}=15V$ | - | 300 | - | pF |
| Output capacitance | C_{oss} | | - | 120 | - | |
| Reverse transfer capacitance | C_{rss} | | - | 80 | - | |
| Total Gate Charge | Q_g | $V_{DS}=15V$ | - | 4.0 | - | nC |
| Gate Source Charge | Q_{gs} | | - | 0.65 | - | |
| Gate Drain Charge | Q_{gd} | | - | 1.5 | - | |
| Turn-on delay Time | $t_{d(on)}$ | $V_{GS}=10V$ | - | 7 | - | ns |
| Rise time | t_r | | - | 55 | - | |
| Turn-off delay Time | $t_{d(off)}$ | | - | 16 | - | |
| Fall time | t_f | | - | 10 | - | |

Reverse Diode Characteristics

| Parameter | Symbol | Test Conditions | Min. | Typ. | Max. | Unit |
|----------------------------|----------|------------------------|------|------|------|------|
| Body Diode Forward Voltage | V_{SD} | $V_{GS}=0V, I_{SD}=1A$ | - | 0.76 | 1.2 | V |
| Reverse Recovery Time | t_{rr} | $V_{GS}=0V, I_{SD}=5A$ | - | 16 | - | ns |
| Reverse Recovery Charge | Q_{rr} | | - | 9 | - | |
| | | $d_i/d_t=100A/\mu s$ | - | | | |

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